



Product Specification

TUDI-MAX489

Full-duplex RS-485 driver and receiver

网址 www.sztdbdt.com 🔍

用芯智造・卓越品质

semiconductor device manufacturer

- Design
- research and development
- production
- and sales



Features

- ●4.75V~5.25V wide power supply, full duplex;
- 1/8 unit load, allowing up to 25 devices to be connected to the bus;
- Short-circuit output protection for the driver;
- Receiver open-circuit failure protection;
- anti-noise capability;
- Integrated transient voltage suppression function;
- Datatransmission rate can reach 12Mbps in an electrical noise environment;
- A, B port protection: HBM±15KV;

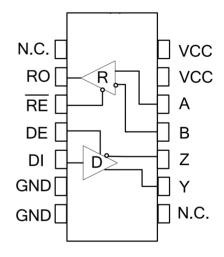


Figure 1 489 Pin layout diagram

Description

489 is a wide-range power supply, full-duplex, low-power RS-485 trans that fully meets the requirements of TIA/EIA-485 standard.

489 includes a driver and a receiver, both which can independently transmit signals.
489 has a load of 1/8, allowing 256 489 transceivers to be connected in parallel on the same

communication bus. Data transmission without errors can be achieved at rates up to 12Mbps. 489 has a working voltage range of 4.75V~5.25V, with fail-safe, current limiting protection, overvoltage protection control port hot plug input and other functions.

489 has excellent ESD discharge capability, with HBM reaching ±15KV.

The 489 has a high-level-active driver enable input and a low-level-active receiver enable input. All are rated for an ambient temperature range of -40° C to 125°C.

Function table

con	trol	input	output
/RE	DE	A-B	RO
0	х	≥-10mV	н
0	х	≤-200mV	L
0	х	Open/short circuit	Н
1	Х	х	Z

conf	trol	input	output	
/RE	DE	DI	Υ	Z
х	1	1	Н	ı
х	1	0	L	H
0	0	х	Z	Z
1	0	х	Z(shut	down)



Pin description

Pin number	Pin name	Pin function
1	NC	No internal connection, no need to connect;
2	RO	Receiver output.When /RE is low, if A-B≥-10mV, RO output is high; if AB≤-200mV, RO output is low.
3	/RE	Receiver output enable control. When /RE is low, the receiver output is enabled and RO is valid; when /RE is high, the receiver is disabled and RO is high impedance; /RE is high and DE is low, the device enters low-power off mode.
4	DE	Driver output enable control. The driver output is active when DE is high, and the output is high-impedance when DE is low; / is high and DE is low, the device enters low-power shutdown mode.
5	DI	DI driver input. A low on DI with DE high causes the driver's A output to be low and B output to be high; a high DI will cause the A output to be high and the B output to be low.
6	GND	grounding
7	GND	grounding
8	NC	No internal connection, no need to connect;
9	Y	Drivers in-phase output
10	Z	Inverting output of the driver
11	В	Inverting input of the receiver
12	А	Receiver in-phase input terminal
13	VCC	This pin can be connected to the power supply (3V \leq VCC \leq 5.5V) or can be left unconnected
14	VCC	Power supply: 3V ≤ VCC ≤ 5.5V

Extreme parameter

Parameter	Symbol	Unit	size
Continuous accusados	SOP14	mW	600
Continuous power consumption	DIP14	mW	700
Power supply voltage	VCC	V	+7
working temperature range		°C	-40~125
Storage temperature range		°C	-60~150
Welding temperature range		°C	300
Control port voltage	DI	V	-0.3~VCC+0.3
Bus side input voltage	A、B	V	-8~13
Receiver output voltage	RO	V	-0.3~VCC+0.3

The maximum limit parameters are values beyond which the device can be damaged in an irreversible manner. Operation of the device under these conditions is not intended to be normal and may affect the reliability of the device if operated continuously at the maximum rated limit. All voltages are referenced to ground.



Parameter	Symbol	Test condition	Minimum	Typical case	Maximum	Un
		Supply current				
6	lcc1	/RE=0V,DE=0V		220	400	u/
Supply current	Icc2	/RE=VCC,DE=		240	400	u/
Turn off the curr-ent	ISHDN	RE=VCC,DE=0V		0.5	10	u/
		ESD protect				
A、B、Y、Z		Human body model(HBM)		±15		K\
Other ports		Human body model(HBM)		±6		K
	The	e DC electrical characteristics of	the receiver			
		VCC=0 or 3.3 V VIN=12 V			125	u/
Input current (A,B)	IN2	VCC=0 or 3.3 V VIN =-7V	-100			u/
Forward input thr- eshold voltage	VIT+	-7V≤VCM≤12 V			-10	m
Reverse input thr- eshold voltage	VIT-	-7V≤VCM≤12 V	-200			m
Input the hystere- sis voltage	Vhys	-7V≤VCM≤12 V	10	30		m
High level output voltage	VoH	loUT=-4mA,VID =+200 mV	VCC-1.5			٧
Low-level output voltage	VoL	loUT=+4mA, VID=-200 mV			0.4	٧
Three-state input leakage current	lozR	0.4V <vo<2.4v< td=""><td colspan="2"></td><td>±1</td><td>u/</td></vo<2.4v<>			±1	u/
Receiver input re- sistance	RN	-7V≤VCM≤12 V	96			ks
Receiver short- circuit current	losR	0V≤Vo≤VCC	±7		±95	m

(If not otherwise, VCC= $4.75V\sim5.25V$, Temp = TMIN \sim TMAX, typical value at Temp = 25) NOTE 1:? VO D and? VOC is the change in VOD and VOC amplitude caused when the DI state of the input signal changes, respectively.





Parameter	Symbol	Test condition	Minimum	Typical case	Maximum	Unit
	The DO	electrical characteristics of t	he drive device			
Drive differential output(no load)	VoD?		3		5.5	٧
Drive differential	l VoD2 —	Graph 2,RL=27 Ω	1.5		VCC	.,
output		Graph 2,RL=50 Ω	2		VCC	V
Changes in the output voltage amplitude (NOTE1)	△VoD	Graph 2,RL=27 Ω			0.2	V
Output common mode voltage	Voc	Graph 2,RL=27 Ω			3	V
Change in common mode output voltage amplitude(NOTE 1)	△Voc	Graph 2,RL=27 Ω			0.2	V
High-level input	VH	DI	2.0			V
Low level input	Vπ	DI			0.8	٧
Logical input cur-rent	IN?	DI	-2		2	uA
Output short circuit current, short circuit to high	losD?	Short-circuit to OV~12V	35		250	mA
Output short circuit current, short circuit to low	losD2	Short-circuit to-7V~OV	-250		-35	mA
		Drive switch characte	ristics			
Drive input to output propagation delay(low to high)	tDPLH			15	35	ns
Drive input to output propagation delay(high to low)	tDPHL	RDIFF=54Ω, CLi= CL?=100 pF		15	35	ns
tDPLH-tDPHL	tsKEW1	(see Figure 3 and Figure 4)		7	10	ns
Up along time / down along time	tDR,tDF			10	25	ns
Amission to output high	tpZH	RL =1109,(see Figure 5,6)		20	90	ns
The enabling to output is low	tpZL			20	90	ns
Input low to no energy	tPLz	RL =110 Ω, (see Figure		20	80	ns
Input high to no energy	tPHZ			20	80	ns
Under off conditions, the output is high	tDSH	RL =1109,(see Figure 5,6)		500	900	ns
Under off conditions, enabling output low	tDSL	RL=1109,(see Figure 5,6)		500	900	ns



Parameter	Symbol	Test condition	Minimum	Typical case	Maximum	Unit
		Receiver Switch charact	teristics			
Ento output high time	tRPZH	C=15 pF is shown in Figure		20	50	ns
From low output to energy-forbidden time	tpRLZ	For CL =15 pF, see Figure 7		20	45	ns
From high output to energy forbidden time	tPRHZ	For CL =15 pF, see Figure 7		20	45	ns
Enables high output time in the off state	tRPSH	For CL =15 pF, see Figure 7		200	1400	ns
Ento output low time in off state	tRPSL	For CL =15 pF, see Figure 7		200	1400	ns
Time in the off state	tsHDN	NOTE2	80		300	ns
Acceptor	tRPLH	See Figure 7 and Figure 8	20	60	90	ns
Input to output propagation latency is from low to high						
The receiver input to output propagation latency is obtained from high to low	tRPHL	VID 2.0V;rise and fall along time VID 15ns	20	60	90	ns
tRPLH-tRPHL	tsKEW2			7	10	ns
Ability to reach the output for a low time	tRPZL	For CL =15 pF, see Figure 7		20	50	ns

Additional description

Introduction

The 489 is a full-duplex high-speed transceiver for RS-485/RS-42 communication, containing a driver and a receiver. It has fail-safe, overvoltage protection, and overcurrent protection. The 489 achieves error-free transmission up to 12Mbps.

fail-safe

The 489 guarantees a logic high receiver output if the receiver input is short-circuited or open-circuited,or drivers connected to the terminated transmission line are disabled (idle). This is achieved by setting the receiver input thresholds to -10mV and -20mV, respectively. RO is logic high if the differential receiver input voltage(A-B)≥-10mV, and RO is logic low the voltage(A-B)≤-200mV. Logic high with a minimum noise margin of 50mV can be realized depending the receiver thresholds. The-10mV to -200mV threshold voltage is in accordance with the EIA/TIA-485 of±200mV.

256 transceivers on the bus

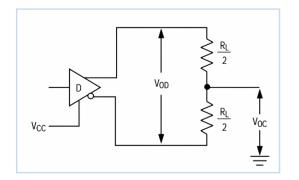
The input impedance of the standard RS485 receiver is $12k\Omega(1 \text{ unit load})$, and the standard driver can drive to 32 unit loads. The receiver of the 489 transceiver has an input impedance of 1/8 unit load ($96k\Omega$, allowing up to 256 transceivers to be connected in parallel on the same communication bus. These devices can be combined arbitrarily, or combined with other 485 transceivers, as long as the total load does not exceed 256 unit loads, they can be connected to the same bus.

Drive output protection

Protection against excessive output current and dissipation by fault or bus contention is provided by overcurrent and overvoltage protection mechanisms, with fast short-circuit throughout the common-mode voltage range(see Typical Operating Characteristics).



Test circuit



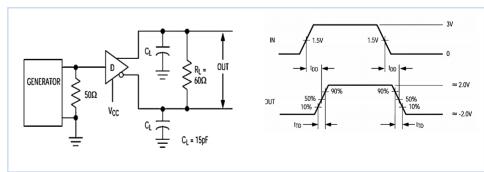


Figure 2: DC test load for the drive

Figure 3 Drive-line Differential Delay and Transit Time

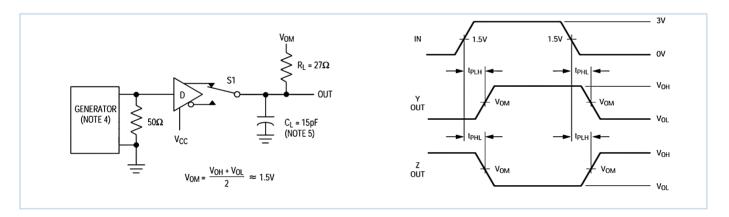


Figure 4 Drive propagation delay

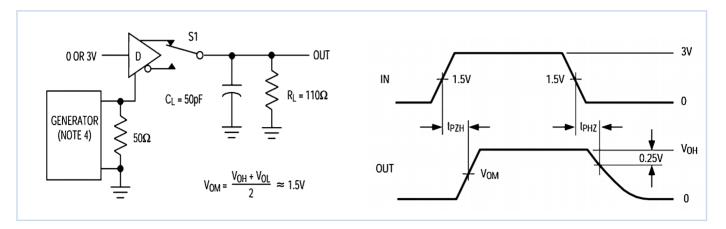


Figure 5 Drive enable and disable time



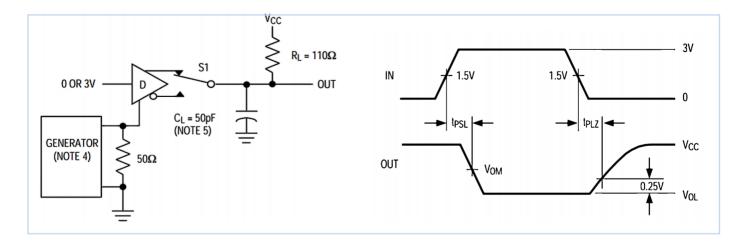


Figure 6 Drive enable and disable time

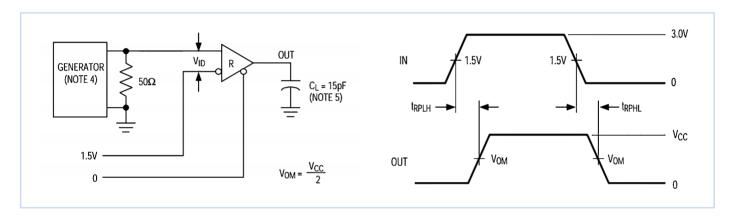
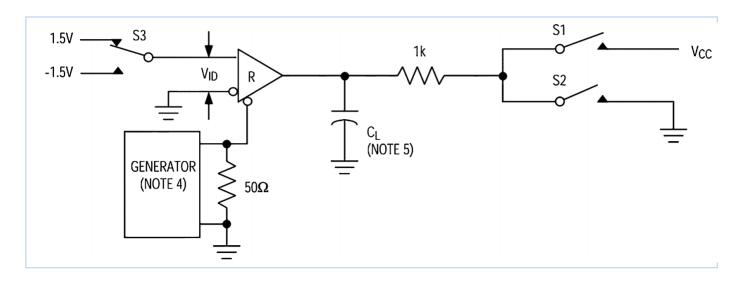


Figure 7: Receiver Propagation Delay Test Circuit





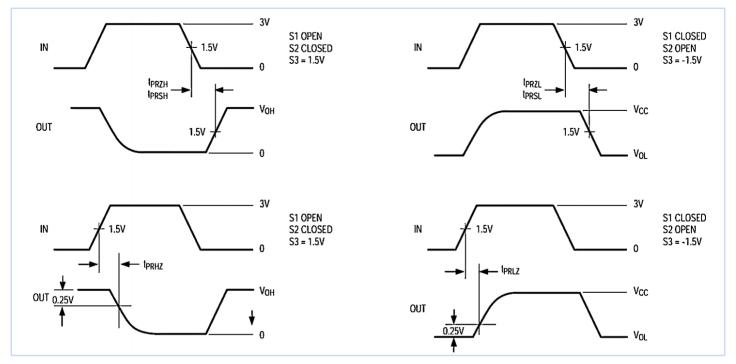


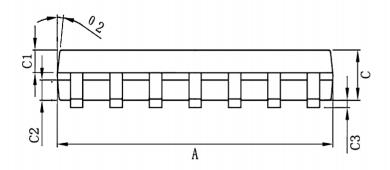
Figure 8 Receive enable and disable time

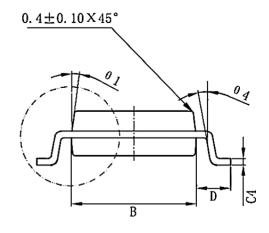
Order information

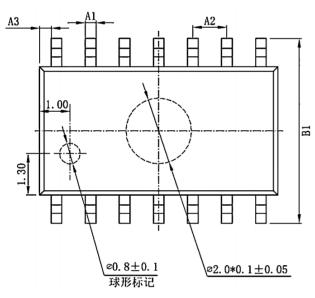
Order Number	Package	Package Quantity	Package Quantity On The park	
MAX489CPD-TUDI	DIP14	Tube,25,A box of 1000	MAX489CPD	
MAX489CSD-TUDI SOP14 MAX489ECPD-TUDI DIP14	Tape,Reel,2500	MAX489CSD	0°C to 70°C	
	DIP14	Tube,25,A box of 1000	MAX489ECPD	0 C to 70 C
MAX489ECSD-TUDI SOP14		Tape,Reel,2500	MAX489ECSD	
MAX489EPD-TUDI	DIP14	Tube,25,A box of 1000	MAX489EPD	
MAX489ESD-TUDI	SOP14	Tape,Reel,2500	MAX489ESD	- 40°C to 85°C
MAX489EEPD-TUDI	DIP14	Tube,25,A box of 1000	MAX489EEPD	- 40 C to 65 C
MAX489EESD-TUDI	SOP14	Tape,Reel,2500	MAX489EESD	

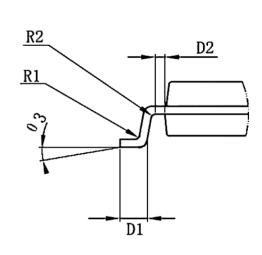


Package SOP14





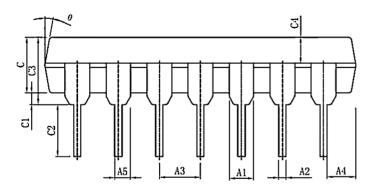


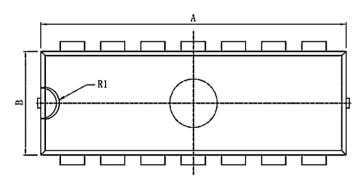


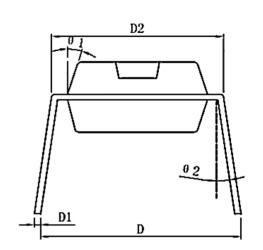
Tagging	Minimum/mm	Maximum value/mm	Tagging	Minimum/mm	Maximum value/mm
Α	8.55	8.75	C4	0.193	0.213
A1	0.356	0.456	D	0.95	1.15
A2	1.27	TYP	D1	0.40	0.70
А3	0.312	2TYP	D2	0.20TYP	
В	3.80	4.00	R1	0.20TYP	
B1	5.80	6.20	R2	0.20TYP	
С	1.40	1.60	θ1	8°~12	°TYP4
C1	0.60	0.70	02	8°~12°TYP4	
C2	0.55	0.65	θ3	0°~8°	
С3	0.05	0.25	θ4	4°~12°	



Package DIP14







Tagging	Minimum/mm	Maximum value/mm	Tagging	Minimum/mm	Maximum value/mm
Α	19.00	19.20	С3	3.85	4.45
A1	1.524	4TYP	C4	1.40	1.50
A2	0.41	0.51	D	8.20	8.80
A3	2.54TYP		D1	0.20	0.35
A4	1.70TYP		D2	7.74	8.00
A5	0.99	ТҮР	θ	10°T	YP4
В	6.30	6.50	θ1	17°T'	YP4
С	3.00	3.20	θ2	6°TYP	
C1	0.51	ТҮР	R1	1.27TYP	
C2	3.00	3.60			



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